Vishay Semiconductors

Option Information

Optocoupler lead-bend configurations are available as options. In addition, partial discharge testing as per VDE / IEC is also available as an option.

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See the order information section in the data sheet to determine if and which options are available to a specific product. Contact the Vishay sales office for other option configurations.

The options are:

Option 1 VDE option

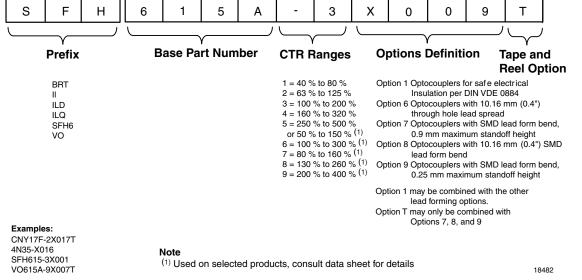
- Option 6 400 mil (10.16 mm) lead spread DIP configuration
- Option 7 Surface mount, gull wing DIP configuration with standoff
- Option 8 Surface mount, gull wing DIP configuration with increased clearance

Option 9 Surface mount, gull wing DIP configuration

ORDERING OPTIONS

A specific option or combination of options can be ordered by add the options definition field following the base part

number and CTR range (if applicable) as presented in the following example:



This field is always 4 characters long and commences with the character X. In the case of surface mounted products in tape and reel format, the tape and reel option character "T" will follow this field.

Notes

- ⁽¹⁾ Not all options are available for all product types.
- (2) The X001T option is only available on products that are available on the following SMD products SFH6106, SFH6156, SFH6186, SFH6206, and SFH6286 series, e.g. SFH6106-3X001T .

OPTION 1 OPTOCOUPLERS FOR SAFE ELECTRICAL INSULATION PER DIN EN 60747-5-5 (VDE 0884)⁽¹⁾

The optocoupler listed are suitable for safe electrical insulation only within the safety maximum ratings. Compliance with the safety maximum ratings must be ensured by protective circuits.

The partial discharge measurement ensures that no partial discharge occurs during operation at maximum permissible operating insulation voltage (V_{IOBM}). Permanent partial discharge affects the insulating materials and can result in a high voltage breakdown.

It is recommended that tests with the insulation test voltage (VISOL) should not be made, otherwise partial discharge may occur impairing the insulation characteristics. Thus partial discharges also may occur at the maximum permissible operating insulation voltage.

The possible combinations for these fields ⁽¹⁾ are:

X001, X006, X007, X008, X009, X001T⁽²⁾, X007T, X008T,

X009T, X016, X017, X018, X019, X017T, X018T, X019T

The insulation test per DIN EN 60747-5-5 (VDE 0884) is carried out after all the other tests

1 For technical questions, contact: optocoupleranswers@vishay.com Document Number: 83713

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Option Information



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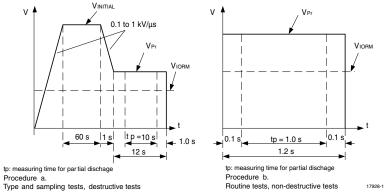


Fig. 1 - Time Voltage Diagram per DIN EN 60747-5-5

DESCRIPTION	SYMBOL	SYSTEM 1			UNIT
		DIP4	DIP8	DIP16	
		SFH610A	ILCT6	ILQ1/2/5/74	
		SFH615A	ILD1/2/5/74	ILQ30/31/55	
		SFH615AA	ILD30/31/55	ILQ32	
		SFH615AGB	ILD32	ILQ66	
		SFH615AGR	ILD66	ILQ615	
		SFH617A	ILD250/1/2	ILQ620	
		SFH618A	ILD255	ILQ620GB	
		SFH620A	ILD621GB	ILQ621	
		SFH620AA	ILD621	ILQ621GB	
		SFH620AGB	ILD621GB		
		SFH628A	ILD755		
		SFH6106	ILD766		
		SFH6116	MCT6		
		SFH6156			
		SFH6186			
		SFH6206			
		SFH6286			
Installation category (DIN VDE 0110)					
For rated line voltages \leq 300 V _{RMS}			I to IV		
For rated line voltages \leq 600 V _{RMS}			I to IV		
For rated line voltages \leq 1000 V _{RMS}					
IEC climatic category (DIN IEC 60068 Part 1/9.80)			55/100/21		
Pollution degree (DIN VDE 0110 Part 1/1.89)			2		
Maximum operation insulating voltage (1)	VIORM		890		V _{peak}
Test voltage input/output, procedure b $^{(1)}$ V _{Pr} = 1.875 x V _{IORM} , routine 100 % test, t _p = 1 s, partial discharge < 5 pC	V _{Pr}	1669		V _{peak}	
Test voltage input/output, procedure a ⁽¹⁾ $V_{Pr} = 1.6 \times V_{IORM}$, type and sampling test $t_p = 60 \text{ s}$, partial discharge < 5 pC	V _{Pr}	1424		V _{peak}	
Maximum permissible overvoltage (transient overvoltage)	V _{IOTM}	10 000		V _{peak}	
Partial discharge test voltage ⁽¹⁾	VINITIAL	8000		V _{peak}	
Safety maximum ratings (maximum permissible ratings in case of a fault, also refer to d diagram) Package temperature Current (input current I _F , $P_{Si} = 0$, $T_A = 25$ °C)	T _{si} I _{si}		175 275		°C mA
Derating with higher ambient temperature Power (output or total power dissipation, $T_A = 25$ °C) Derating with higher ambient temperature	ΔI _{Si} P _{Si} ΔP _{Si}		-1.83 400 -2.67		mA/K mW mW/K
Insulation resistance at T _{Si} V _{I/O} = 500 V	R _{IS}		> 10 ⁹		W

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2 For technical questions, contact: <u>optocoupleranswers@vishay.com</u> Document Number: 83713

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Option Information

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DESCRIPTION	SYMBOL	SYSTEM 2			UNIT
		4N25/26/27/28	IL250	MCT5210	
		4N35/36/37/38/39	IL251	MCT5211	
		4N32/33	IL252	SFH600	
		CNY17	IL255	SFH601	
		CNY17F	IL400	SFH608	
		H11A	IL755	SFH640	
		H11AA1	IL755B	MOC8050	
		H11B	IL766	IL56B	
		H11B1	IL766B	MOC8021	
		H11C	MCA230/231	MOC8112	
		H11D	MCA255	MOC8102/03/04/05	
		IL1/2/5/74	MCT2/2E	VO610A	
		IL2B	MCT270/271	VO615A	
		IL30/31/55	MCT272	VO617A	
		IL55B	MCT273/274	VO618A	
		IL66	MCT275	VO615C	
		IL66B	MCT276/277	VO617C	
		IL201/202/203			
Installation category (DIN VDE 0110)			I		
For rated line voltages \leq 300 V _{RMS}			I to IV		
For rated line voltages \leq 600 V _{RMS}			I to IV		
For rated line voltages \leq 1000 V _{RMS}					
IEC climatic category (DIN IEC 60068 Part 1/9.80)			55/100/21		
Pollution degree (DIN VDE 0110 Part 1/1.89)			2		
Maximum operation insulating voltage (1)	VIORM	890			V _{peak}
Test voltage input/output, procedure b $^{(1)}$ V _{Pr} = 1.875 x V _{IORM} , routine 100 % test, t _p = 1 s, partial discharge < 5 pC	V _{Pr}		1669		V _{peak}
Test voltage input/output, procedure a $^{(1)}$ V_{Pr} = 1.6 x V_{IORM} , type and sampling test t_p = 60 s, partial discharge < 5 pC	V _{Pr}	1424		V _{peak}	
Maximum permissible overvoltage (transient overvoltage)	V _{IOTM}	8000			V _{peak}
Partial discharge test voltage ⁽¹⁾	V _{INITIAL}		8000		V _{peak}
Safety maximum ratings (maximum permissible ratings in case of a fault, also refer to diagram) Package temperature Current (input current I _F , P _{Si} = 0, T _A = 25 °C) Derating with higher ambient temperature Power (output or total power dissipation, T _A = 25 °C) Derating with higher ambient temperature	T _{si} I _{si} DI _{Si} P _{Si} ΔP _{Si}		175 400 -2.67 700 -4.67		°C mA mA/K mW mW/K
Insulation resistance at T _{Si} V _{I/O} = 500 V	R _{IS}		> 10 ⁹		W

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Option Information

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DESCRIPTION	SYMBOL	SYSTEM 4 ⁽²⁾	SYSTEM 5	SYSTEM 7	UNIT
		IL410	6N135	IL300	
		IL420	6N136	IL300E	
		IL4116	SFH6135	IL300F	
		IL4117	SFH6136	IL300EF	
		IL4118	6N138	IL300DEFG	
		IL4216	SFH6138		
		IL4217	SFH6139		
		IL4218	6N139		
			SFH6345		
			6N137		
			VO2601		
			VO2611		
			VO2630		
			VO2631		
			VO4661		
Installation category (DIN VDE 0110)					
For rated line voltages ≤ 300 V _{RMS}		I to IV	I to IV	I to IV	
For rated line voltages \leq 600 V _{RMS}		I to III	I to IV	I to IV	
For rated line voltages ≤ 1000 V _{RMS}					
IEC climatic category (DIN IEC 60068 Part 1/9.80)		55/100/21	55/100/21	55/100/21	
Pollution degree (DIN VDE 0110 Part 1/1.89)		2	2	2	
Maximum operation insulating voltage (1)	V _{IORM}	890	890	890	V _{peak}
Test voltage input/output, procedure b $^{(1)}$ V_{Pr} = 1.875 x V_{IORM} , routine 100 % test, t_p = 1 s, partial discharge < 5 pC	V _{Pr}	1669	1669	1669	V _{peak}
Test voltage input/output, procedure a ⁽¹⁾ $V_{Pr} = 1.6 \times V_{IORM}$, type and sampling Test $t_p = 60$ s, partial discharge < 5 pC	V _{Pr}	1424	1424	1424	V _{peak}
Maximum permissible overvoltage (transient overvoltage)	V _{IOTM}	8000	8000	8000	V _{peak}
Partial discharge test voltage ⁽¹⁾	VINITIAL	8000	8000	8000	V _{peak}
Safety maximum ratings (maximum permissible ratings in case of a fault, also refer to diagram)		175	175	105	
Package temperature Current (input current I _F , P _{Si} = 0, T _A = 25 °C)	T _{si} I _{si}	175 250	175 300	165 235	°C mA
Derating with higher ambient temperature Power (output or total power dissipation, $T_A = 25$ °C) Derating with higher ambient temperature	DI _{Si} P _{Si} ∆P _{Si}	-1.65 500 -3.33	-2 500 -3.33	-1.57 465 -3.1	mA/K mW mW/K
Insulation resistance at T _{Si} V _{I/O} = 500 V	R _{IS}	> 10 ⁹	> 10 ⁹	> 10 ⁹	W

Notes

All voltages referred to are peak values except otherwise specified.

⁽¹⁾ See time-test voltage diagram

(2) In preparation

Testing input / output voltage requires all input pins and all output pins to be shorted

Option 1: Tested per DIN EN 60747-5-2 (VDE 0884) / DIN EN 60747-5-5 (pending)

Option 6: Wide lead spacing (10.16 mm creepage / clearance distances > 8 mm)

Option 7: Surface mount leads (creepage / clearance distances > 8 mm)

Option 8: Surface mount leads

Option 9: Surface mount leads

See CECC 00802, edition 1, for soldering conditions for SMT devices (option 7 and 9).

"-.." means dash selections

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Option Information Vishay Semiconductors

V_{RMS} or DC

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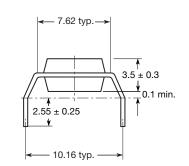
OPTION 6 DIP OPTOCOUPLERS WITH 0.4" (10.16 mm) LEAD SPREAD

The leads of the optocouplers are bent according to a spacing of 0.4" (10.16 mm). Dimensions deviating from the standard type are:

Lead spacing 10.16 mm (0.4") Creepage distance > 8 mm Clearance > 8 mm

This version additionally complies with the following standards:

• IEC 60950 DIN VDE 0805/05 90 (System 2 and 3 only) Reinforced insulation up to an operating voltage of 400



Clearance-creepage distance = 8 mm min. See standard version for pin configuration

OPTION 7 LEAD BENDS FOR SURFACE MOUNT OPTOCOUPLERS

These optocouplers are suitable for surface mounting. Dimensions deviating from the standard type are:

Creepage distance > 8 mm Clearance distance > 8 mm

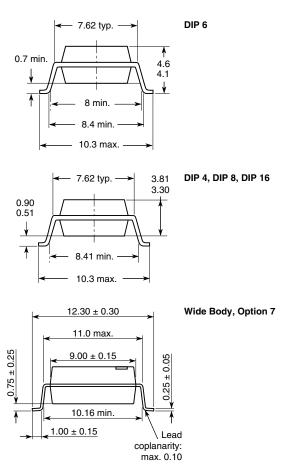
This version additionally complies with the following

 standards:
IEC 60950 DIN VDE 0805/05 90 (system 2 and 3 only) Reinforced insulation up to an operating voltage of 400 V_{BMS} or DC

During the soldering process, the package should not be wetted with tin-lead solder to prevent the impairment of the isolation features. Apart from iron soldering, only reflow soldering methods (vapor phase, infrared and hot gas) are permissible.

Permissible soldering conditions for SMD bending options: please see reflow soldering profile.

The soldering process may be repeated two times at the most. Attention must be paid to the cooling down of the device to $25 \,^{\circ}$ C between the soldering processes.



Clearance and creepage distances must be considered for the solder pad design.

Clearance-creepage distance = 8 mm min.

See standard version for pin configuration.



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OPTION 8

LEAD BENDS FOR SURFACE MOUNT OPTOCOUPLERS

These optocouplers are suitable for surface mounting. Dimensions deviating from the standard type are:

Creepage distance > 8 mm

Clearance distance > 8 mm

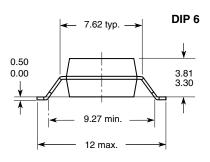
This version additionally complies with the following standards:

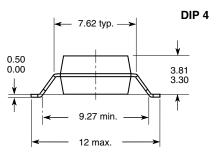
- IEC 60950 DIN VDE 0805/05 90 (system 2 and 3 only) Reinforced insulation up to an operating voltage of 400 $V_{\rm RMS}$ or DC

During the soldering process, the package should not be wetted with tin-lead solder to prevent the impairment of the isolation features. Apart from iron soldering, only reflow soldering methods (vapor phase, infrared and hot gas) are permissible.

Permissible soldering conditions for SMD bending options: please see reflow soldering profile.

The soldering process may be repeated two times at the most. Attention must be paid to the cooling down of the device to $25 \,^{\circ}$ C between the soldering processes.





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Clearance and creepage distances must be considered for the solder pad design.

Clearance-creepage distance = 8 mm min.

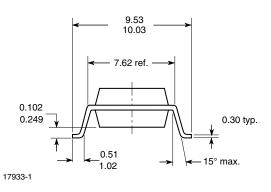
See standard version for pin configuration.

OPTION 9 LEAD BENDS FOR SURFACE MOUNT OPTOCOUPLERS

During the soldering process, the package should not be wetted with tin-lead solder to prevent the impairment of the isolation features. Apart from iron soldering, only reflow soldering methods (vapor phase, infrared and hot gas) are permissible.

Permissible soldering conditions for SMD bending options: please see reflow soldering profile.

The soldering process may be repeated two times at the most. Attention must be paid to the cooling down of the device to $25 \,^{\circ}$ C between the soldering processes.



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Option Information

Vishay Semiconductors

MARKINGS

Product marking is defined in the datasheets. In the cases where marking is not defined in the datasheet, the following table defines the option information that is marked on the product.

OPTION TYPE	MARKING	
X001, X001T	X001, X1 ⁽¹⁾	
X006	No mark	
X007, X007T	X007	
X008, X008T	X008	
X009, X009T	No mark	
X016	X001	
X017, X017T	X017	
X018, X018T	X018	
X019, X019T	X001	

Note

 $^{(1)}$ X1 is used on the SOP and SOIC-8 where there are space constraints.

Note

The information in this document provides generic information on options but for specific information on a product the appropriate product datasheet should be used.